18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

Rev. 3 — 23 January 2018

Product data sheet

1 General description

The 74ALVT162823 18-bit bus interface register is designed to eliminate the extra packages required to buffer existing registers and provide extra data width for wider data or address paths of buses carrying parity.

The 74ALVT162823 has two 9-bit wide buffered registers with clock enable ($n\overline{CE}$) and master reset ($n\overline{MR}$) which are ideal for parity bus interfacing in high microprogrammed systems.

The registers are fully edge-triggered. The state of each D input, one set-up time before the LOW-to-HIGH clock transition is transferred to the corresponding Q output of the flip-flop.

The 74ALVT162823 is designed with 30 Ω series resistance in both the pull-up and pull-down output structures. This design reduces line noise in applications such as memory address drivers, clock drivers, and bus receivers or transmitters.

2 Features and benefits

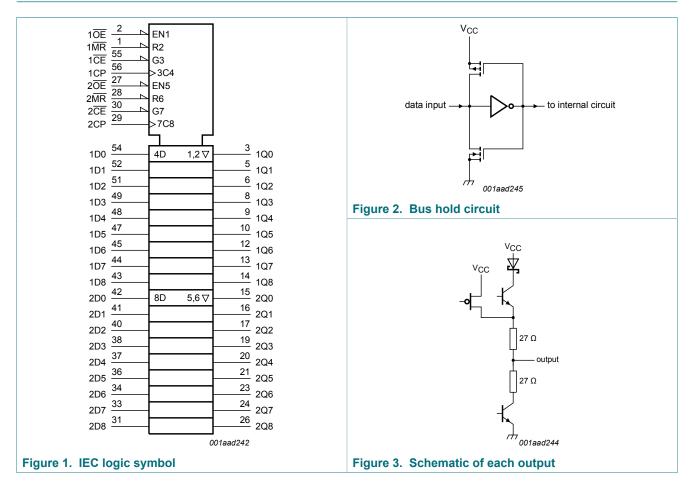
- Two sets of high speed parallel registers with positive edge-triggered D-type flip-flops
- 5 V I/O compatible
- Ideal where high speed, light loading or increased fan-in are required with MOS microprocessors
- Bus hold data inputs eliminate the need for external pull-up resistors to hold unused inputs
- Live insertion and extraction permitted
- Power-up 3-state
- Power-up reset
- Output capability: +12 mA to -12 mA
- Outputs include series resistance of 30 Ω making external termination resistors unnecessary
- Latch-up protection:
 - JESD78: exceeds 500 mA
- ESD protection:
 - MIL STD 883, method 3015: exceeds 2000 V
 - MM: exceeds 200 V

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3 Ordering information

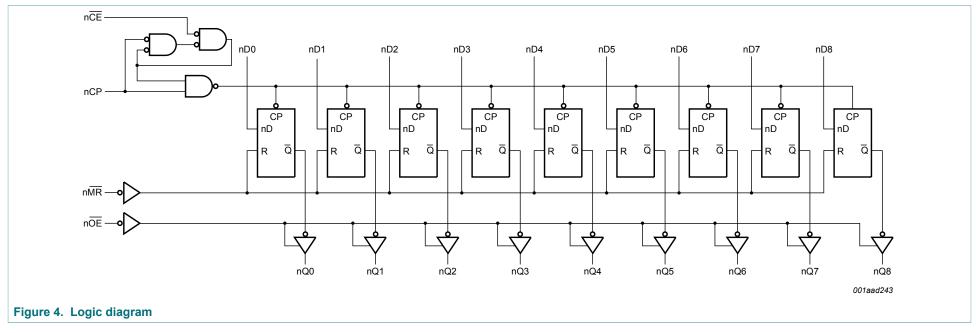
Table 1. Ordering information								
Type number Package								
	Temperature range	Name	Description	Version				
74ALVT162823DGG	−40 °C to +85 °C	TSSOP56	plastic thin shrink small outline package; 56 leads; body width 6.1 mm	SOT364-1				

4 Functional diagram



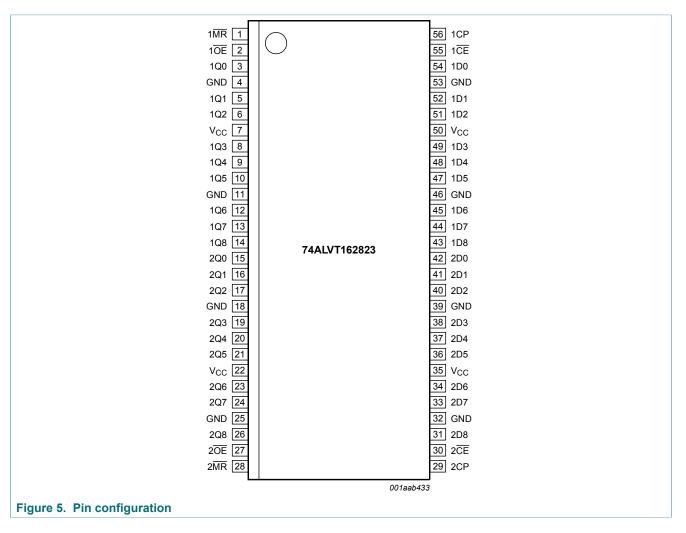
74ALVT162823

18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state



5 **Pinning information**

5.1 Pinning



5.2 Pin description

Table 2. Pin description		
Symbol	Pin	Description
1D0, 1D1, 1D2, 1D3, 1D4, 1D5, 1D6, 1D7, 1D8	54, 52, 51, 49, 48, 47, 45, 44, 43	data inputs
1Q0, 1Q1, 1Q2, 1Q3, 1Q4, 1Q5, 1Q6, 1Q7, 1Q8	3, 5, 6, 8, 9, 10, 12, 13, 14	data outputs
2D0, 2D1, 2D2, 2D3, 2D4, 2D5, 2D6, 2D7, 2D8	42, 41, 40, 38, 37, 36, 34, 33, 31	data inputs
2Q0, 2Q1, 2Q2, 2Q3, 2Q4, 2Q5, 2Q6, 2Q7, 2Q8	15, 16, 17, 19, 20, 21, 23, 24, 26	data outputs
1MR, 2MR	1, 28	master reset input (active-LOW)
1 <u>0E</u> , 2 <u>0E</u>	2, 27	output enable inputs (active LOW)
1CP, 2CP	56, 29	clock pulse inputs (active rising edge)
1CE, 2CE	55, 30	clock enable input (active-LOW)
GND	4, 11, 18, 25, 32, 39, 46, 53	ground (0 V)
V _{CC}	7, 22, 35, 50	supply voltage

6 Functional description

Table 3. Function table ^[1]

Operating mode	Input					Output
	nOE	nMR	nCE	nCP	nDn	nQn
Clear	L	L	Х	Х	Х	L
Load and read data	L	Н	L	1	h	Н
					I	L
Hold	L	Н	Н	NC	Х	NC
High-impedance	Н	Х	Х	Х	Х	Z

[1] H = HIGH voltage level;

h = HIGH voltage level one set-up time prior to the LOW-to-HIGH clock transition;

L = LOW voltage level;

I = LOW voltage level one set-up time prior to the LOW-to-HIGH clock transition;

NC = no change;

X = don't care;

Z = high-impedance OFF-state;

 \uparrow = LOW-to-HIGH clock transition;

Limiting values 7

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134); voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Мах	Unit
V _{CC}	supply voltage		-0.5	+4.6	V
VI	input voltage	[1]	-0.5	+7.0	V
Vo	output voltage	output in OFF-state or HIGH-state [1]	-0.5	+7.0	V
I _{IK}	input clamping current	V _I < 0 V	-	-50	mA
I _{OK}	output clamping current	V _O < 0 V	-	-50	mA
I _O	output current	output in LOW-state	-	128	mA
		output in HIGH-state	-	-64	mA
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature	[2]	-	150	°C

 The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.
 The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

Recommended operating conditions 8

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC} = 2.	5 V					
V _{CC}	supply voltage		2.3	-	2.7	V
VI	input voltage		0	-	5.5	V
I _{OH}	HIGH-level output current		-	-	-8	mA
I _{OL}	LOW-level output current		-	-	12	mA
Δt/Δv	input transition rise or fall rate	outputs enabled	-	-	10	ns/V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C
V _{CC} = 3.3	3 V					
V _{CC}	supply voltage		3.0	-	3.6	V
VI	input voltage		0	-	5.5	V
I _{OH}	HIGH-level output current		-	-	-12	mA
I _{OL}	LOW-level output current		-	-	12	mA
Δt/Δv	input transition rise or fall rate	outputs enabled	-	-	10	ns/V
T _{amb}	ambient temperature	in free air	-40	-	+85	°C

9 Static characteristics

Table 6. Static characteristics

At recommended operating conditions; $T_{amb} = -40$ °C to +85 °C; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Typ ^[1]	Max	Unit
V _{CC} = 2.	5 V ± 0.2 V					1	
V _{IK}	input clamping voltage	V _{CC} = 2.3 V; I _{IK} = -18 mA		-	-0.85	-1.2	V
V _{IH}	HIGH-level input voltage			1.7	-	-	V
V _{IL}	LOW-level input voltage			-	-	0.7	V
V _{OH}	HIGH-level output voltage	V _{CC} = 2.3 V; I _O = -8 mA		1.7	2.5	-	V
V _{OL}	LOW-level output voltage	V _{CC} = 2.3 V; I _O = 12 mA		-	0.3	0.5	V
V _{OL(pu)}	power-up LOW-level output voltage	V_{CC} = 2.7 V; I _O = 1 mA; V _I = V _{CC} or GND	[2]	-	0.2	0.55	V
I	input leakage current	control pins					
		V _{CC} = 2.7 V; V _I = GND		-	0.1	±1	μA
		V _{CC} = 2.7 V; V _I = 5.5 V		-	0.1	10	μA
		I/O data pins	[3]				
		V _{CC} = 2.7 V; V _I = 5.5 V		-	0.1	10	μA
		$V_{CC} = 2.7 \text{ V}; \text{ V}_{I} = V_{CC}$		-	0.5	1	μA
		V _{CC} = 2.7 V; V _I = 0 V		-	0.1	-5	μA
I _{OFF}	power-off leakage current	V_{CC} = 0 V; V _I or V _O = 0 V to 4.5 V		-	0.1	±100	μA
I _{BHL}	bus hold LOW current	data inputs; V_{CC} = 2.5 V; V_{I} = 0.7 V	[4]	-	100	-	μA
I _{BHH}	bus hold HIGH current	data inputs; V_{CC} = 2.5 V; V_{I} = 1.7 V	[4]	-	-70	-	μA
I _{EX}	external current	output HIGH-state when $V_O > V_{CC}$; $V_O = 5.5 V$; $V_{CC} = 2.5 V$		-	10	125	μA
I _{O(pu\pd)}	power-up/power-down output current	$V_{CC} \le 1.2 \text{ V}; V_O = 0.5 \text{ V to } V_{CC};$ V _I = GND or V _{CC}	[5]	-	1	±100	μA
l _{oz}	OFF-state output current	V_{CC} = 2.7 V; V_{I} = V_{IL} or V_{IH}					
		output HIGH state; V _O = 2.3 V		-	0.5	5	μA
		output LOW-state; $V_0 = 0.5 V$		-	0.5	-5	μA
I _{CC}	supply current	V_{CC} = 2.7 V; V_{I} = GND or V_{CC} ; I_{O} = 0 A					
		outputs HIGH-state		-	0.04	0.1	mA
		outputs LOW-state		-	2.7	4.5	mA
		outputs disabled	[6]	-	0.04	0.1	mA

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18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

Symbol	nbol Parameter Conditions			Min	Min Typ ^[1]		Unit	
ΔI _{CC}	additional supply current	per input pin; V_{CC} = 2.3 V to 2.7 V; one input at V_{CC} - 0.6 V, other inputs at V_{CC} or GND	[7]	-	0.04	0.4	mA	
Cl	input capacitance	$V_{I} = 0 V \text{ or } V_{CC}$		-	3	-	pF	
Co	output capacitance	V _{I/O} = 0 V or 3.0 V		-	9	-	pF	
V _{CC} = 3.3	3 V ± 0.3 V							
V _{IK}	input clamping voltage	V _{CC} = 3.0 V; I _{IK} = -18 mA		-	-0.85	-1.2	V	
V _{IH}	HIGH-level input voltage			2.0	-	-	V	
V _{IL}	LOW-level input voltage			-	-	0.8	V	
V _{OH}	HIGH-level output voltage	$V_{CC} = 3.0 \text{ V}; I_{O} = -12 \text{ mA}$	$V_{\rm CC} = 3.0 \text{ V}; I_{\rm O} = -12 \text{ mA}$		2.3	-	V	
V _{OL}	LOW-level output voltage	V _{CC} = 3.0 V; I _O = 12 mA		-	0.5	0.8	V	
V _{OL(pu)}	power-up LOW-level output voltage	V_{CC} = 3.6 V; I _O = 1 mA; V _I = V _{CC} or GND	$6 \text{ V}; \text{ I}_{\text{O}} = 1 \text{ mA}; \text{ V}_{\text{I}} = \text{V}_{\text{CC}} \text{ or GND} $ ^[2]		-	0.55	V	
I	input leakage current	control pins						
		V_{CC} = 3.6 V; V_{I} = V_{CC} or GND		-	0.1	±1	μA	
		V _{CC} = 0 V or 3.6 V; V _I = 5.5 V		-	0.1	10	μA	
		I/O data pins	[3]					
		V _{CC} = 3.6 V; V _I = 5.5 V		-	0.1	10	μA	
		$V_{CC} = 3.6 \text{ V}; \text{ V}_{I} = V_{CC}$		-	0.5	1	μA	
		V _{CC} = 3.6 V; V _I = 0 V		-	0.1	-5	μA	
I _{OFF}	power-off leakage current	V_{CC} = 0 V; V ₁ or V ₀ = 0 V to 4.5 V		-	0.1	±100	μA	
I _{BHL}	bus hold LOW current	data inputs; V_{CC} = 3 V; V_{I} = 0.8 V		75	130	-	μA	
I _{BHH}	bus hold HIGH current	data inputs; V_{CC} = 3 V; V_{I} = 2.0 V		-75	-140	-	μA	
I _{BHLO}	bus hold LOW overdrive current	data inputs; V_{CC} = 3.6 V; V_{I} = 0 V to 3.6 V	[8]	500	-	-	μA	
I _{BHHO}	bus hold HIGH overdrive current	data inputs; V_{CC} = 3.6 V; V_{I} = 0 V to 3.6 V	[8]	-500	-	-	μA	
I _{EX}	external current	output HIGH-state when $V_O > V_{CC}$; $V_O = 5.5 V$; $V_{CC} = 3.0 V$		-	10	125	μA	
I _{O(pu\pd)}	power-up/power-down output current	$V_{CC} \le 1.2 \text{ V}; V_O = 0.5 \text{ V} \text{ to } V_{CC};$ $V_I = \text{GND or } V_{CC}$	[9]	-	1	±100	μA	
l _{oz}	OFF-state output current	V_{CC} = 3.6 V; V_{I} = V_{IL} or V_{IH}						
		output HIGH state; V _O = 3.0 V		-	0.5	5	μA	
		output LOW-state; V _O = 0.5 V		-	0.5	-5	μA	
I _{CC}	supply current	V_{CC} = 3.6 V; V_{I} = GND or V_{CC} ; I_{O} = 0 A						
		outputs HIGH-state		-	0.05	0.1	mA	
		outputs LOW-state		-	3.9	5.5	mA	
		outputs disabled	[6]	-	0.06	0.1	mA	

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18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

Symbol	Parameter	Conditions	Min	Typ ^[1]	Max	Unit
ΔI _{CC}	additional supply current	per input pin; V_{CC} = 3 V to 3.6 V; [7] one input at V_{CC} - 0.6 V, other inputs at V_{CC} or GND	-	0.04	0.4	mA
CI	input capacitance	V _I = 0 V or V _{CC}	-	3	-	pF
Co	output capacitance	$V_{I/O} = 0 V \text{ or } 3.0 V$	-	9	-	pF

[1] All typical values for V_{CC} = 2.5 V \pm 0.2 V are measured at V_{CC} = 2.5 V and T_{amb} = 25 °C.

All typical values for V_{CC} = 3.3 V ± 0.3 V are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

[2] For valid test results, data must not be loaded into the flip-flops after applying power.

[3] Unused pins at V_{CC} or GND.

[4] Not guaranteed.

[5] This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms. From V_{CC} = 1.2 V to V_{CC} = 2.5 V ± 0.2 V a transition time of 100 μs is permitted. This parameter is valid for T_{amb} = 25 °C only.

[6] I_{CC} is measured with outputs pulled up to V_{CC} or pulled down to ground.

[7] This is the increase in supply current for each input at the specified voltage level other than V_{CC} or GND.

[8] This is the bus hold overdrive current required to force the input to the opposite logic state.

[9] This parameter is valid for any V_{CC} between 0 V and 1.2 V with a transition time of up to 10 ms. From V_{CC} = 1.2 V to V_{CC} = 3.3 V ± 0.3 V a transition time of 100 µs is permitted. This parameter is valid for T_{amb} = 25 °C only.

10 Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V); $T_{amb} = -40$ °C to +85 °C; for test circuit see Figure 10.

Symbol	Parameter	Conditions	Min	Typ ^[1]	Мах	Unit
V _{CC} = 2.	5 V ± 0.2 V		1	I		
t _{PLH}	LOW to HIGH propagation delay	nCP to nQn; see Figure 6	2.1	3.7	5.8	ns
t _{PHL}	HIGH-to-LOW propagation delay	nCP to nQn; see Figure 6	2.0	2.8	4.6	ns
		nMR to nQn; see Figure 8	2.0	3.0	4.6	ns
t _{PZH}	OFF-state to HIGH propagation delay	nOE to nQn; see Figure 9	2.8	4.4	6.6	ns
t _{PZL}	OFF-state to LOW propagation delay	nOE to nQn; see Figure 9	2.0	3.4	5.2	ns
t _{PHZ}	HIGH to OFF-state propagation delay	nOE to nQn; see Figure 9	2.3	3.2	4.6	ns
t _{PLZ}	LOW to OFF-state propagation delay	nOE to nQn; see Figure 9	2.0	2.5	3.5	ns
t _{su(H)}	set-up time HIGH	nDn to nCP; see Figure 7	1.0	0.5	-	ns
		nCE to nCP; see Figure 7	1.0	0.2	-	ns
t _{su(L)}	set-up time LOW	nDn to nCP; see Figure 7	2.0	1.3	-	ns
		nCE to nCP; see Figure 7	0.5	-0.1	-	ns
t _{h(H)}	hold time HIGH	nDn to nCP; see Figure 7	0.1	-1.4	-	ns
		nCE to nCP; see Figure 7	1.0	0.2	-	ns
t _{h(L)}	hold time LOW	nDn to nCP; see Figure 7	0.1	-0.5	-	ns
		nCE to nCP; see Figure 7	1.0	-0.1	-	ns
t _W	pulse width	nCP HIGH; see Figure 6	2.0	0.8	-	ns
		nCP LOW	3.0	2.1	-	ns
		nMR LOW; see Figure 8	2.0	0.8	-	ns
t _{rec}	recovery time	nMR to nCP; see Figure 8	2.3	1.3	-	ns

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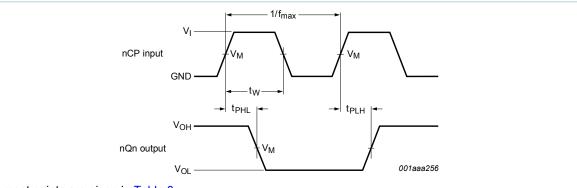
18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

Symbol	Parameter	Conditions	Min	Typ ^[1]	Мах	Unit
V _{CC} = 3.	3 V ± 0.3 V				<u> </u>	
t _{PLH}	LOW to HIGH propagation delay	nCP to nQn; see <u>Figure 6</u>	1.8	2.9	4.4	ns
t _{PHL}	HIGH-to-LOW propagation delay	nCP to nQn; see Figure 6	1.6	2.3	3.6	ns
		nMR to nQn; see Figure 8	1.8	2.5	3.7	ns
t _{PZH}	OFF-state to HIGH propagation delay	nOE to nQn; see Figure 9	2.0	3.5	5.2	ns
t _{PZL}	OFF-state to LOW propagation delay	nOE to nQn; see Figure 9	1.7	2.8	3.8	ns
t _{PHZ}	HIGH to OFF-state propagation delay	nOE to nQn; see Figure 9	2.4	3.5	4.7	ns
t _{PLZ}	LOW to OFF-state propagation delay	nOE to nQn; see Figure 9	1.9	2.8	3.8	ns
t _{su(H)}	set-up time HIGH	nDn to nCP; see Figure 7	1.0	0.5	-	ns
		nCE to nCP; see Figure 7	1.0	0.1	-	ns
t _{su(L)}	set-up time LOW	nDn to nCP; see Figure 7	1.6	1.1	-	ns
		nCE to nCP; see Figure 7	0.5	-0.5	-	ns
t _{h(H)}	hold time HIGH	nDn to nCP; see Figure 7	0.1	-0.5	-	ns
		nCE to nCP; see Figure 7	1.0	-0.1	-	ns
t _{h(L)}	hold time LOW	nDn to nCP; see Figure 7	0.1	-0.7	-	ns
		nCE to nCP; see Figure 7	1.0	0.5	-	ns
t _W	pulse width	nCP HIGH; see Figure 6	1.5	0.7	-	ns
		nCP LOW	2.5	1.4	-	ns
		nMR LOW; see Figure 8	2.0	1.5	-	ns
t _{rec}	recovery time	nMR to nCP; see Figure 8	2.0	1.1	-	ns

[1] All typical values for V_{CC} = 2.5 V ± 0.2 V are measured at V_{CC} = 2.5 V and T_{amb} = 25 °C. All typical values for V_{CC} = 3.3 V ± 0.3 V are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

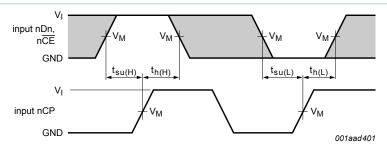
10.1 Waveforms and test circuit



Measurement points are given in Table 8.

 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

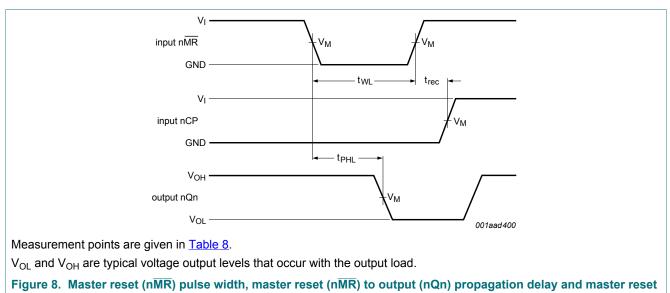
Figure 6. Propagation delay clock input (nCP) to output (nQn), clock pulse (nCP) width HIGH and maximum clock frequency



Measurement points are given in Table 8.

The shaded areas indicate when the input is permitted to change for predictable output performance.

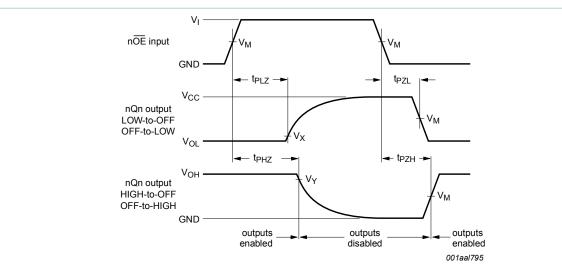
Figure 7. Data set-up and hold times



(nMR) to clock (nCP) recovery time

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Measurement points are given in Table 8.

 V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Figure 9. OFF-state to HIGH and LOW propagation delays and LOW and HIGH to OFF-state propagation delays

Table 8. Measurement points

V _{cc}	Input	Output				
	V _M	V _M	V _Y			
≤ 2.7 V	0.5 x V _{CC}	0.5 x V _{CC}	V _{OL} + 0.15 V	V _{OH} - 0.15 V		
≥ 3.0 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} - 0.3 V		

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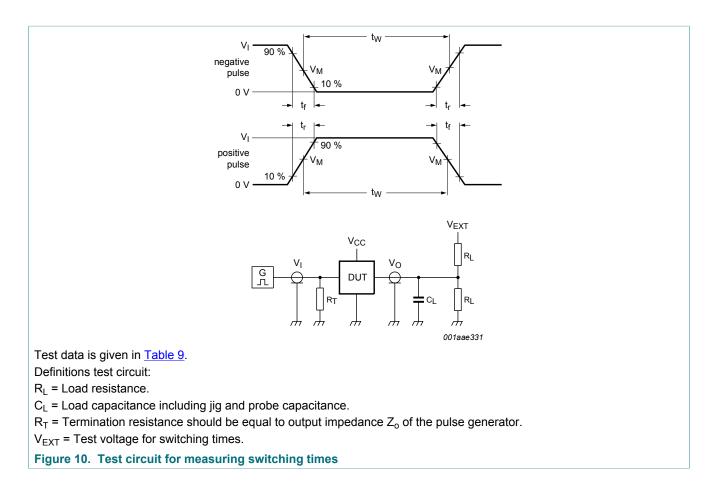
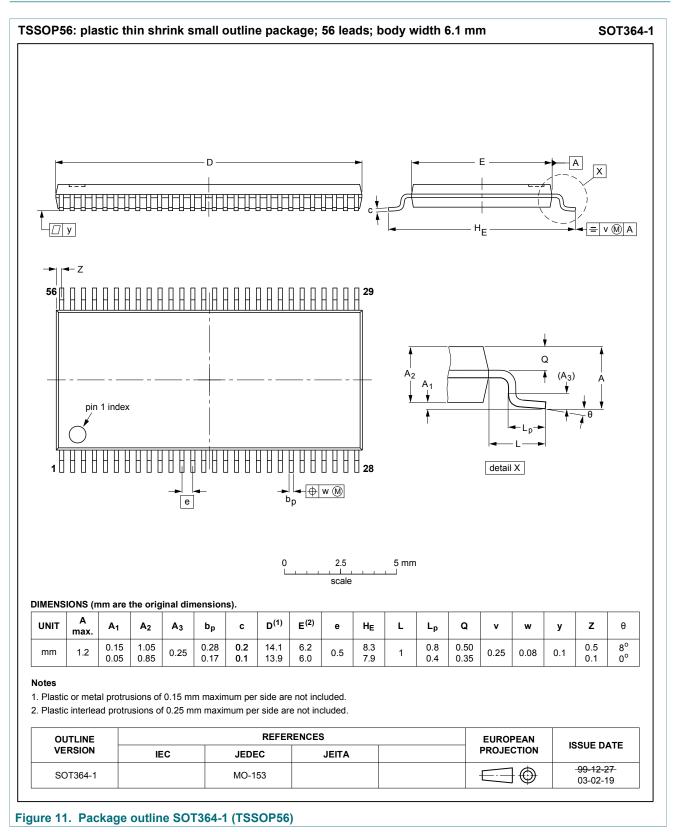


Table 9. Test data

Input			Load		V _{EXT}			
VI	f _i	tw	t _r , t _f	CL	RL	t _{PHZ} , t _{PZH}	t _{PLZ} , t _{PZL}	t _{PLH} , t _{PHL}
3.0 V or V_{CC} whichever is less	≤ 10 MHz	500 ns	≤ 2.5 ns	50 pF	500 Ω	GND	6 V or V_{CC} x 2	open

18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

11 Package outline



12 Abbreviations

Table 10. Abbreviations				
Acronym	Description			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
MIL	Military			
MM	Machine Model			
MOS	Metal-Oxide Semiconductor			

13 Revision history

|--|

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74ALVT162823 v.3	20180123	Product data sheet	-	74ALVT162823 v.2	
Modifications:	 The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. Type number 74ALVT162823DL (SOT371-1 / SSOP56) removed. 				
74ALVT162823 v.2	20050811	Product data sheet	-	74ALVT162823 v.1	
Modifications:	 The format of this data sheet has been redesigned to comply with the new presentation and information standard of Philips Semiconductors. <u>Section 2</u>: modified 'Jedec Std 17' into 'JESD78' <u>Section 10</u>: changed propagation delays. 				
74ALVT162823 v.1	19980827	Product specification	-	-	

14 Legal information

14.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

Please consult the most recently issued document before initiating or completing a design. [1]

The term 'short data sheet' is explained in section "Definitions".

[2] [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nexperia.com.

14.2 Definitions

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74ALVT162823 **Product data sheet**

18-bit bus-interface D-type flip-flop with reset and enable with 30 Ω termination resistors; 3-state

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